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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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APR 14 2003

TECHNOLOGY CENTER 2800

In re Application of:

Rome Bloomfield et al.

Serial No.: 10/039,138

Filed: December 31, 2001

For: METHOD AND APPARATUS FOR  
GROUNDING A PROCESSOR BOARD

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Group Art Unit: 2833

Examiner: Gilman, A.

Atty. Docket: NUHP:0115  
200301800-1

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4/21/03  
Juni  
(W.C.)

Assistant Commissioner  
for Patents  
Washington, D.C. 20231

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37 C.F.R. 1.8

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April 14, 2003  
Date

Tait R. Swanson

Sir:

AMENDMENT AND RESPONSE

In response to the Official Action mailed January 13, 2003, Applicants amend and remark as follows:

**AMENDMENTS**

Please amend claim 1 as follows:

1. (Amended) A method of electrically grounding a circuit board to a chassis comprising the steps of:

attaching an electrically conducting mounting stud to chassis;  
attaching a ground clip adjacent a mounting hole in the circuit board;  
positioning the mounting stud through the mounting hole; and  
positively engaging the ground clip with opposite sides of the mounting stud.